

Z-PACK | Z-PACK HM-eZd+

TE Internal #: 2170902-1 High Speed Backplane Connectors, 80 Position, Mating Alignment, Polarization Mating Alignment Type, 8 Row, 10 Column, PCB Mount Header, Z-PACK HM-eZd+

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Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



Connector System: Board-to-Board Number of Positions: 80 Row-to-Row Spacing: 4.5 mm [.177 in] Mating Alignment: With Mating Alignment Type: Polarization

Features

Product Type Features

Signal Arrangement Connector System Differential

Board-to-Board

PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Unshrouded
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Pairs per Column	4
Card Slot Centerline	25.4 mm
Number of Positions	80
Number of Rows	8
Number of Columns	10
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	42 VAC
Body Features	
Primary Product Color	Black
Contact Features	

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Contact Mating Area Length	4.3 mm[.169 in]
PCB Contact Termination Area Plating Material Thickness	.5 – 2.5 μm[20 – 100 μin]
Contact Type	Pin
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Mating Area Plating Material	Gold
PCB Contact Termination Area Plating Material Finish	Matte
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	.5 A
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Mechanical Attachment	
Mating Alignment	With
Mating Alignment Type	Polarization
Connector Mounting Type	Board Mount
Housing Features	
Number of Shrouded Sides	0
Housing Material	LCP (Liquid Crystal Polymer)
Centerline (Pitch)	2.5 mm[.098 in]
Dimensions	
PCB Hole Diameter	.36 mm
Row-to-Row Spacing	4.5 mm[.177 in]
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
Durability Rating	200 Cycles
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Box & Tube

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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

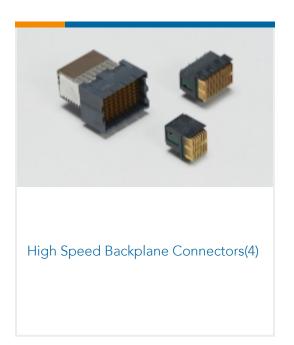
Compatible Parts



Also in the Series Z-PACK HM-eZd+

High Speed Backplane Connectors, 80 Position, Mating Alignment, Polarization Mating Alignment Type, 8 Row, 10 Column, PCB Mount Header, Z-PACK HM-eZd+





Customers Also Bought



Documents

Product Drawings

HM-EZD+,4PAIRS,10COLS,VERTICAL,ASSEMBLY

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2170902-1_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2170902-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2170902-1_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

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Product Specifications Application Specification

English

Product Environmental Compliance Product Compliance English

Product Compliance

English